



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET POWERDI

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
01	16mΩ @ V _{GS} = 10V		9.0A
Q1	30V	$20m\Omega @ V_{GS} = 4.5V$	8.0A
Q2	30V	$28m\Omega$ @ $V_{GS} = -10V$	-6.8A
Q2		$38m\Omega @ V_{GS} = -4.5V$	-5.8A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Power Management Functions
- Analog Switch

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

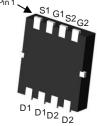
Mechanical Data

- Case: POWERDI[®]3333-8 (Type UXB)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Waiting Update
- Terminal: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

POWERDI®3333-8 (Type UXB)

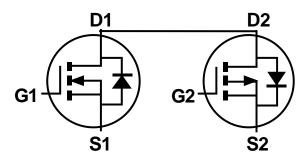






Bottom View

Equivalent Circuit



N-Channel MOSFET

P-Channel MOSFET

Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3016LNS-7	POWERDI®3333-8 (Type UXB)	2000/Tape & Reel
DMC3016LNS-13	POWERDI®3333-8 (Type UXB)	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



SG5 = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 16 for 2016)
WW = Week Code (01 to 53)



Maximum Ratings Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	I _D	9.0 7.1	А		
Maximum Body Diode Forward Current (Note 6)	Is	2	Α		
Pulsed Drain Current (380µs pulse, Duty cycle = 1%	I _{DM}	55	Α		
Avalanche Current (L = 0.1mH) (Note 7)	I _{AS}	22	Α		
Avalanche Energy (L = 0.1mH) (Note 7)			E _{AS}	24	mJ

Maximum Ratings Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	-30	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = -10V	I _D	-6.8 -5.7	А		
Maximum Body Diode Forward Current (Note 6)	I _S	-2	Α		
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%	I _{DM}	-40	Α		
Avalanche Current (L = 0.1mH) (Note 7)	I _{AS}	-22	Α		
Avalanche Energy (L = 0.1mH) (Note 7)			E _{AS}	24	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = +25°C	P_{D}	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ hetaJA}$	98	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	2.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	65	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	12	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C



Electrical Characteristics N-CHANNEL - Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	I	-	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I_{GSS}	1	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						_
Gate Threshold Voltage	V _{GS(TH)}	1.4	-	2.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance			12	16	mΩ	$V_{GS} = 10V, I_D = 7A$
Static Dialii-Source Off-Resistance	R _{DS(ON)}	I	16	20	1112.2	$V_{GS} = 4.5V, I_D = 7A$
Diode Forward Voltage	V_{SD}	I	0.70	1.2	٧	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	-	1184	_		\\ 45\\\\\ 0\\
Output Capacitance	Coss	-	137	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C_{rss}		107	_		I = 1.0IVIH2
Gate Resistance	R_g	_	3.0	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	ļ	9.5	_		
Total Gate Charge (V _{GS} = 10V)	Qg	_	21	_	nC	V _{DS} = 15V. I _D = 12A
Gate-Source Charge	Q_{gs}	-	3.8	-	IIC	V _{DS} = 15V, I _D = 12A
Gate-Drain Charge	Q_{gd}	-	4.1	-		
Turn-On Delay Time	t _{D(ON)}	_	4.5	_		
Turn-On Rise Time	t _R	_	3.3	-	ns	$V_{DD} = 15V, V_{GS} = 10V,$
Turn-Off Delay Time	t _{D(OFF)}	Í	14	_	ns	$R_L = 1.5\Omega$, $R_G = 3\Omega$
Turn-Off Fall Time	t_F	I	3.6	_		
Reverse Recovery Time	t _{RR}		9.3	=	ns	I_ = 12A di/dt = 500A/us
Reverse Recovery Charge	Q_{RR}	_	2.5	_	nC	I _F = 12A, di/dt = 500A/μs

Electrical Characteristics P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	=	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-1.2	-	-2.4	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance			22	28	mΩ	$V_{GS} = -10V, I_D = -7A$
Static Dialii-Source Off-Resistance	R _{DS(ON)}	1	32	38	11122	$V_{GS} = -4.5V$, $I_D = -6.2A$
Diode Forward Voltage	V_{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -2.1A$
DYNAMIC CHARACTERISTICS (Note 9)	-					•
Input Capacitance	C _{iss}	-	1,188	=		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Output Capacitance	Coss	-	154	=	pF	$V_{DS} = -15V$, $V_{GS} = 0V$, $f = 1MHz$
Reverse Transfer Capacitance	C _{rss}	-	116	=		
Gate Resistance	Rg	_	9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Q_{g}	-	9.5	-		
Total Gate Charge (V _{GS} = -10V)	Q_{g}	-	19.7	-	nC	\/ 45\/ 1 70
Gate-Source Charge	Q_{gs}	-	3.1	-	IIC	$V_{DS} = -15V, I_{D} = -7A$
Gate-Drain Charge	Q _{qd}	-	3.2	-		
Turn-On Delay Time	t _{D(ON)}	_	3.7	-		
Turn-On Rise Time	t _R	-	2.6	-		$V_{GS} = -10V, V_{DS} = -15V,$
Turn-Off Delay Time	t _{D(OFF)}	_	36	_	ns	$R_G = 6\Omega$, $I_D = -7A$
Turn-Off Fall Time	t _F	-	22	-		
Reverse Recovery Time	t _{RR}	_	10.4	-	ns	1 70 4:/4+ 4000/
Reverse Recovery Charge	Q _{RR}	_	3.2	_	nC	$I_F = -7A$, di/dt = 100A/ μ s

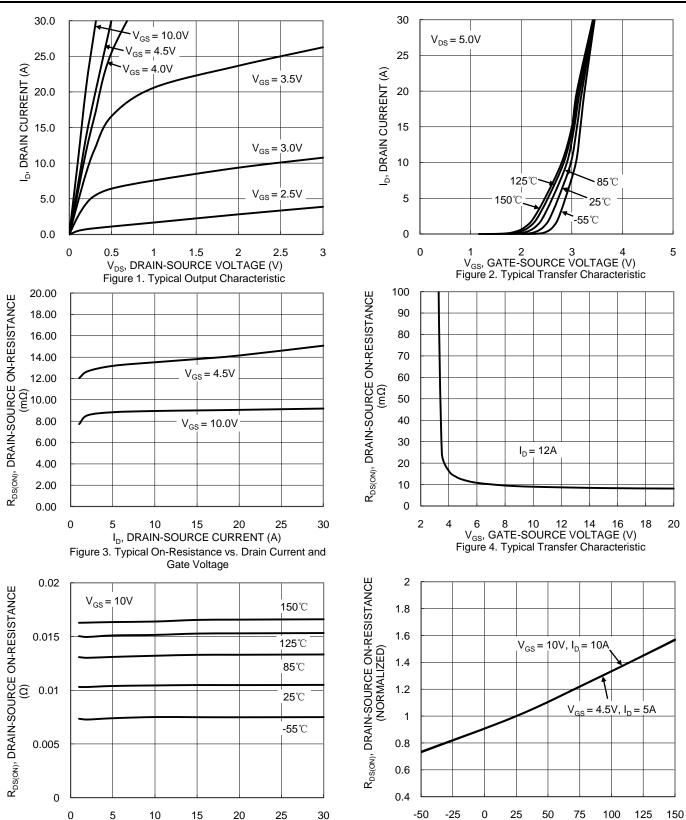
Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

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Typical Characteristics - N-CHANNEL



I_D, DRAIN CURRENT (A)

Figure 5. Typical On-Resistance vs. Drain Current and Temperature

 $\label{eq:TJ} \textbf{J}, \textbf{JUNCTION TEMPERATURE} \ (^{\circlearrowright})$ Figure 6. On-Resistance Variation with Temperature



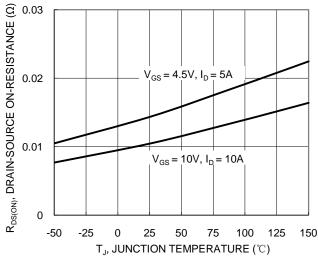
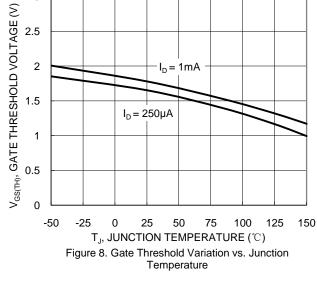
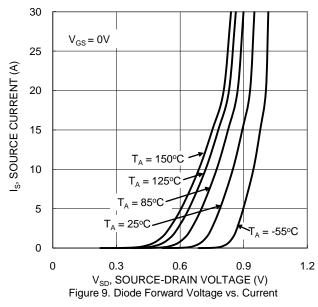
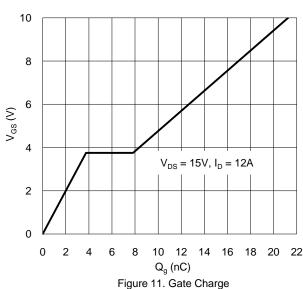


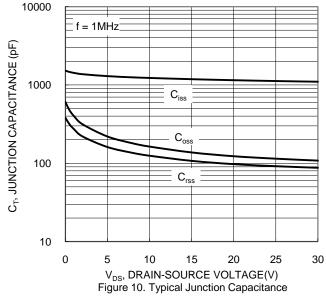
Figure 7. On-Resistance Variation with Temperature

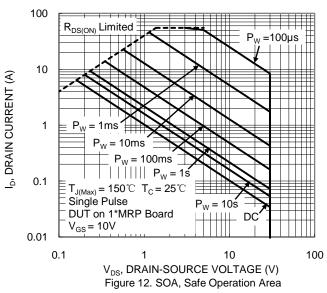


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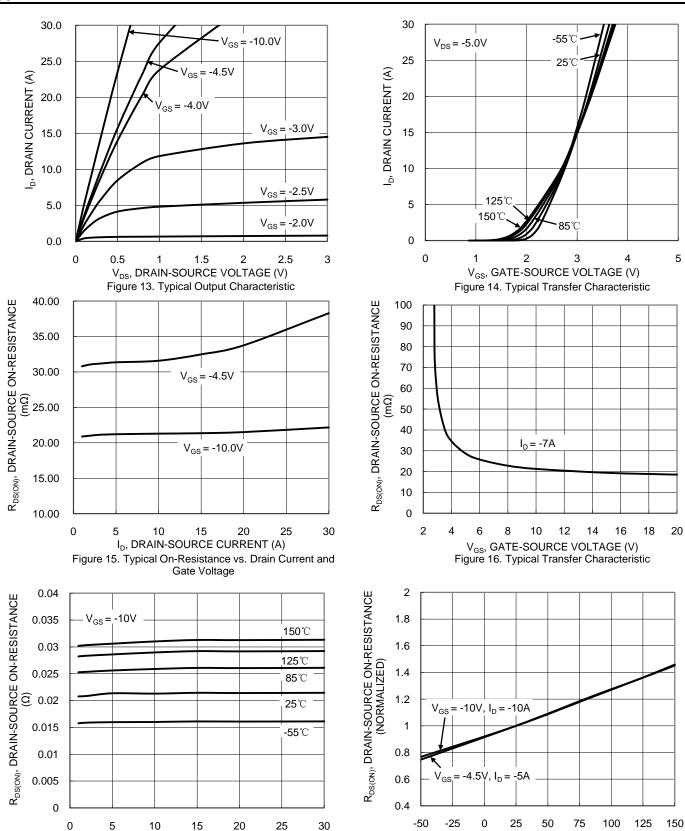








Typical Characteristics - P-CHANNEL



 $\rm I_{\rm D},$ DRAIN CURRENT (A) Figure 17. Typical On-Resistance vs. Drain Current and

Temperature

T_J, JUNCTION TEMPERATURE (°C)

Figure 18. On-Resistance Variation with Temperature





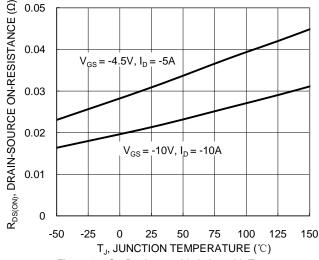
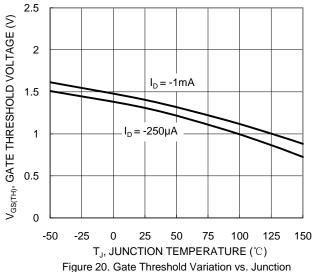
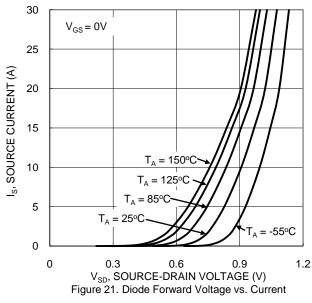
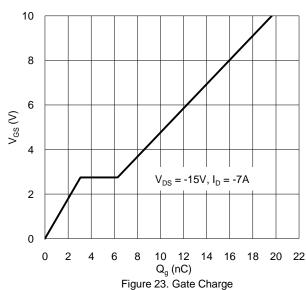


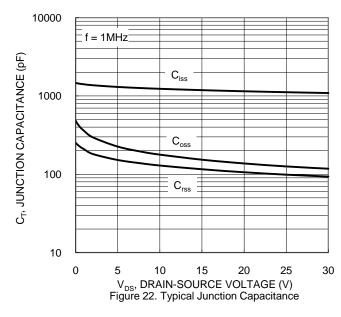
Figure 19. On-Resistance Variation with Temperature

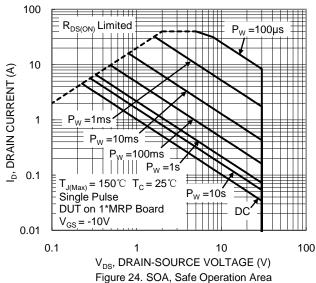


Temperature











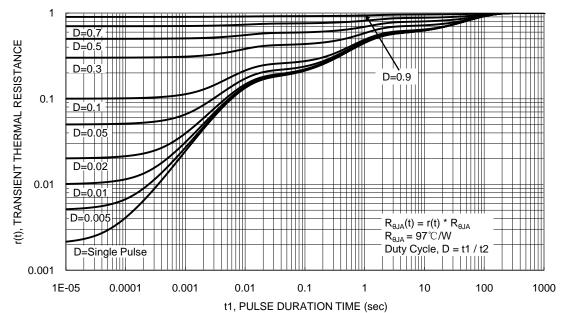


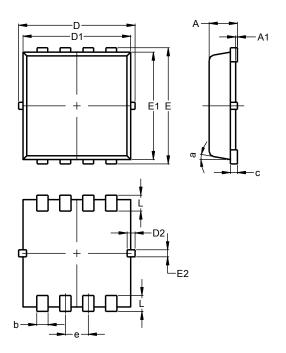
Figure 25. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI®3333-8 (Type UXB)

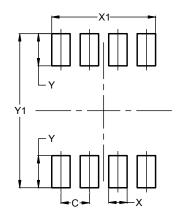


POWERDI®3333-8						
(Type UXB)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A 1	0.00	0.05				
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	0.10	0.35	0.23			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	0.10	0.30	0.20			
е	_	_	0.65			
L	0.35	0.55	0.45			
а	0°	12°	10°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI®3333-8 (Type UXB)



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	2.370
Υ	0.730
Y1	3.500



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